

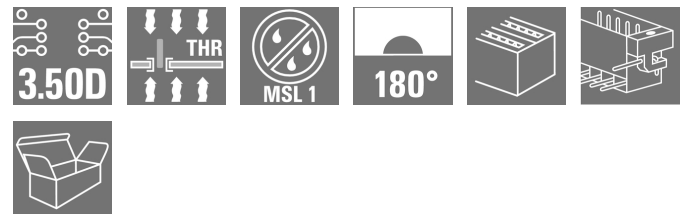
**S2C-SMT 3.50/12/180LF 3.5AU BK BX****Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

**Product image**

Similar to illustration

**High-temperature-resistant pin header.**

- touch-safe
- can be plugged into B2CF 3.50 PUSH IN female plug
- Plug-in direction is perpendicular or parallel to the circuit board (180° / 90°)
- Housing variants: closed (G) and with solder flange (LF)
- Box packaging (BX) or, anti-static, tape-on-reel (RL)
- Suitable for reflow and wave soldering applications
- Pin length of either 1.5 mm or 3.5 mm

**General ordering data**

Version	PCB plug-in connector, male header, Solder flange, THT/THR solder connection, 3.50 mm, Number of poles: 12, 180°, Solder pin length (l): 3.5 mm, Au (Gold), black, Box
Order No.	<a href="#">1519940000</a>
Type	S2C-SMT 3.50/12/180LF 3.5AU BK BX
GTIN (EAN)	4050118327335
Qty.	66 pc(s).
Product data	IEC: 200 V / 13.4 A UL: 150 V / 10 A
Packaging	Box

Creation date May 7, 2025 11:03:50 AM CEST

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**Technical data****Dimensions and weights**

Depth	10.8 mm	Depth (inches)	0.425 inch
Height	17.7 mm	Height (inches)	0.697 inch
Height of lowest version	14.2 mm	Width	28 mm
Width (inches)	1.102 inch	Net weight	4.268 g

**System specifications**

Product family	OMNIMATE Signal - series B2C/S2C 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.114 "	Outgoing elbow	180°
Number of poles	12	Number of solder pins per pole	1
Solder pin length (l)	3.5 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.0 mm, Octagonal	Solder pin dimensions = d tolerance	+0,01 / -0,03 mm
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D)	+ 0,1 mm
Outside diameter of solder pad	2.1 mm	Template aperture diameter	19 mm
L1 in mm	17.5 mm	L1 in inches	0.689 "
Number of rows	1	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	finger-safe unplugged/ back-of-hand-safe plugged	Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged
Can be coded	Yes	Plugging force/pole, max.	3.5 N
Pulling force/pole, max.	3.5 N		

**Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	Au (Gold)	Layer structure of solder connection	1...3 mm Ni / 2...5 µm Sn glossy
Layer structure of plug contact	1...3 µm Ni / 2...5 µm Sn / 0.8...1.2 µm Au	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-40 °C
Temperature range, installation, max.	120 °C		

**Rated data acc. to IEC**

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	13.4 A
Rated current, min. number of poles (Tu=40°C)	12 A	Rated voltage for surge voltage class / pollution degree II/2	200 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	80 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

**Rated data acc. to CSA**

Rated voltage (Use group B / CSA)	150 V	Rated voltage (Use group C / CSA)	50 V
Rated voltage (Use group D / CSA)	150 V	Rated current (Use group B / CSA)	9.5 A
Rated current (Use group C / CSA)	9.5 A	Rated current (Use group D / CSA)	9.5 A

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**Technical data****Rated data acc. to UL 1059**

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 150 V

Rated voltage (Use group C / UL 1059) 50 V

Rated current (Use group B / UL 1059) 10 A

Rated current (Use group C / UL 1059) 10 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

**Packing**

Packaging Box

VPE length 342 mm

VPE width 134 mm

VPE height 21 mm

Surface resistance  $R_s = 10^9 - 10^{12} \Omega$ Width Pick & Place Pad ( $W_{PPP}$ ) 10 mmLength Pick & Place Pad ( $L_{PPP}$ ) 15.6 mmProtrusion 1 Pick & Place Pad ( $L_{01 (PPP)}$ ) 7.8 mmProtrusion 2 Pick & Place Pad ( $P_{02 (PPP)}$ ) 7.8 mm**Classifications**

ETIM 6.0 EC002637

ETIM 7.0 EC002637

ETIM 8.0 EC002637

ETIM 9.0 EC002637

ETIM 10.0 EC002637

ECLASS 9.0 27-44-04-02

ECLASS 9.1 27-44-04-02

ECLASS 10.0 27-44-04-02

ECLASS 11.0 27-46-02-01

ECLASS 12.0 27-46-02-01

ECLASS 13.0 27-46-02-01

ECLASS 14.0 27-46-02-01

ECLASS 15.0 27-46-02-01

**Environmental Product Compliance**

RoHS Compliance Status Compliant without exemption

REACH SVHC No SVHC above 0.1 wt%

**Important note**

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load
- Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

**Approvals**

Approvals

Approvals MAMID [https://mdcop.weidmueller.com/mediadelivery/rendition/900\\_319230/-T1z1mm-S800/](https://mdcop.weidmueller.com/mediadelivery/rendition/900_319230/-T1z1mm-S800/)

UL File Number Search UL Website

Certificate No. (cURus) E60693

Creation date May 7, 2025 11:03:50 AM CEST

Catalogue status 26.04.2025 / We reserve the right to make technical changes.

### S2C-SMT 3.50/12/180LF 3.5AU BK BX

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## Technical data

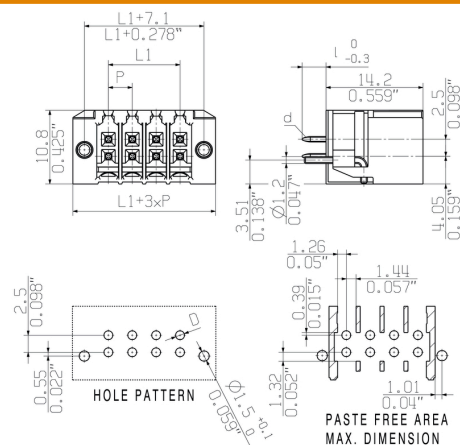
### Downloads

Product Change Notification	<a href="#">Changeover of the locking hook for the solder flange pin of the S2C-SMT 3.50 and S2L-SMT 3.50</a>
Catalogues	<a href="#">Catalogues in PDF-format</a>
Brochures	<a href="#">FL DRIVES EN</a> <a href="#">FL DRIVES DE</a>
White paper surface mount technology	<a href="#">Download Whitepaper</a>

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**Drawings****Dimensional drawing**

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[www.weidmueller.com](http://www.weidmueller.com)**Accessories****Coding elements****Only connects what is supposed to be connected:  
the right connection at the right place.**

Coding elements and locking devices clearly assign connecting elements during the manufacturing process and operation

The coding elements and locking devices are inserted prior to assembly or during the cable assembly phase. The Weidmüller alternative: configure online using the variant configurator to precode prior to delivery.

Incorrect assembly on the circuit board and incorrect plugging of connecting elements is no longer possible. The advantage: no troubleshooting during manufacture and no operational errors by the user.

**General ordering data**

Type	B2L/S2L 3.50 KO OR BX	Version	Product data	Packaging
Order No.	<a href="#">1849730000</a>	PCB plug-in connector, Accessories, Coding element, orange, Number		Box
GTIN (EAN)	4032248378197	of poles: 1		
Qty.	100 pc(s).			
Type	B2L/S2L 3.50 KO BK BX	Version	Product data	Packaging
Order No.	<a href="#">1849740000</a>	PCB plug-in connector, Accessories, Coding element, black, Number		Box
GTIN (EAN)	4032248378203	of poles: 1		
Qty.	100 pc(s).			

## Recommended wave soldering profiles

**Weidmüller Interface GmbH & Co. KG**  
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Germany  
Fon: +49 5231 14-0  
Fax: +49 5231 14-292083  
[www.weidmueller.com](http://www.weidmueller.com)

### Single Wave:



### Double Wave:



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

## Recommended reflow soldering profile

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D-32758 Detmold

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## Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3\text{K/s}$ . In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq -6\text{K/s}$  solder is cured. Board and components cool down while avoiding cold cracks.